



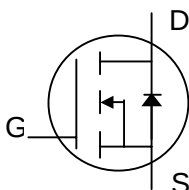
N-channel Enhancement-mode Power MOSFET

Simple Drive Requirement

100% Avalanche Tested

Fast Switching Speed

RoHS-compliant, halogen-free



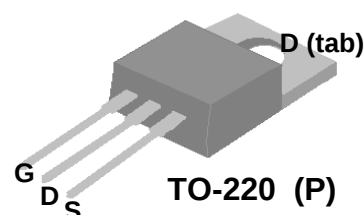
BV_{DSS}	900V
$R_{DS(ON)}$	5.2 Ω
I_D	3A

Description

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, low on-resistance and cost-effectiveness.

The AP03N90P-HF-3 provides high blocking voltage to overcome voltage surge and sag in the toughest power systems and is well suited for universal 90~265VAC off-line AC/DC converter applications.

The TO-220 through-hole package is widely used in commercial and industrial applications where a small pcb footprint or an attached heatsink are required.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	900	V
V_{GS}	Gate-Source Voltage	± 30	V
I_D at $T_C=25^\circ\text{C}$	Continuous Drain Current	3	A
I_D at $T_C=100^\circ\text{C}$	Continuous Drain Current	1.89	A
I_{DM}	Pulsed Drain Current ¹	10	A
P_D at $T_C=25^\circ\text{C}$	Total Power Dissipation	83.3	W
	Linear Derating Factor	0.67	W/ $^\circ\text{C}$
E_{AS}	Single Pulse Avalanche Energy ³	4.5	mJ
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

Thermal Data

Symbol	Parameter	Value	Unit
Rthj-c	Maximum Thermal Resistance, Junction-case	1.5	$^\circ\text{C}/\text{W}$
Rthj-a	Maximum Thermal Resistance, Junction-ambient	62	$^\circ\text{C}/\text{W}$

Ordering Information

AP03N90P-HF-3TB : in RoHS-compliant halogen-free TO-220, shipped in tubes, (50 pcs/tube)



Electrical Specifications at $T_j=25^{\circ}\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	900	-	-	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance ²	$V_{GS}=10V, I_D=1.2A$	-	-	5.2	Ω
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2	-	4	V
g_{fs}	Forward Transconductance	$V_{DS}=10V, I_D=1A$	-	2	-	S
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=720V, V_{GS}=0V$	-	-	25	μA
I_{GSS}	Gate-Source Leakage	$V_{GS}=\pm 30V, V_{DS}=0V$	-	-	± 100	nA
Q_g	Total Gate Charge ²	$I_D=1A$	-	18	29	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=480V$	-	3.5	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{GS}=10V$	-	7	-	nC
$t_{d(on)}$	Turn-on Delay Time ²	$V_{DD}=300V$	-	20	-	ns
t_r	Rise Time	$I_D=1A$	-	14	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=50\Omega$	-	105	-	ns
t_f	Fall Time	$V_{GS}=10V$	-	24	-	ns
C_{iss}	Input Capacitance	$V_{GS}=0V$	-	800	1280	pF
C_{oss}	Output Capacitance	$V_{DS}=25V$	-	55	-	pF
C_{rss}	Reverse Transfer Capacitance	$f=1.0\text{MHz}$	-	4	-	pF
R_g	Gate Resistance	$f=1.0\text{MHz}$	-	4	6	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ²	$I_S=1.2A, V_{GS}=0V$	-	-	1.5	V
t_{rr}	Reverse Recovery Time ²	$I_S=1A, V_{GS}=0V$	-	320	-	ns
Q_{rr}	Reverse Recovery Charge	$dI/dt=100A/\mu s$	-	1.3	-	μC

Notes:

1. Pulse width limited by maximum junction temperature.
3. Pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
2. Starting $T_j=25^{\circ}\text{C}$, $V_{DD}=50V$, $L=1\text{mH}$, $R_G=25\Omega$

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

APEC DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

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Typical Electrical Characteristics

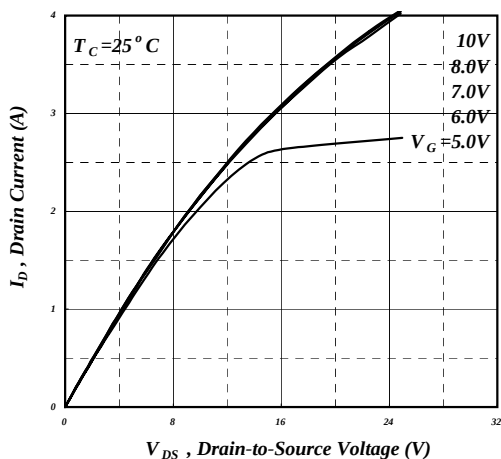


Fig 1. Typical Output Characteristics

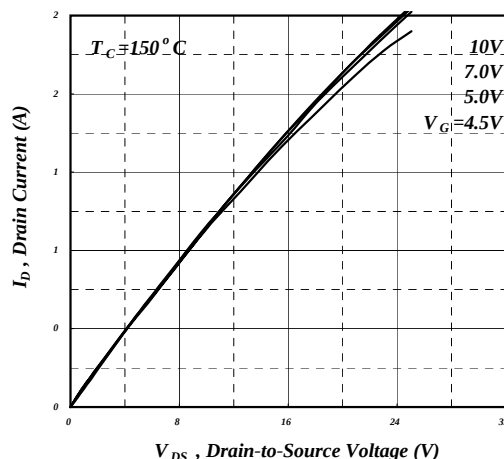


Fig 2. Typical Output Characteristics

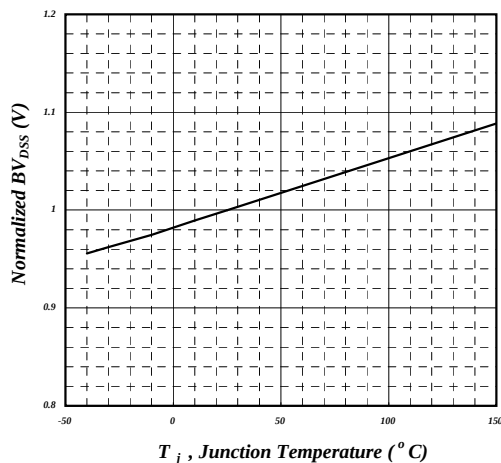


Fig 3. Normalized BV_{DSS}
vs. Junction Temperature

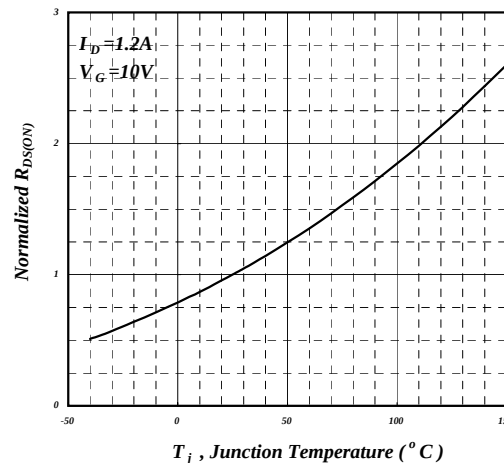


Fig 4. Normalized On-Resistance
vs. Junction Temperature

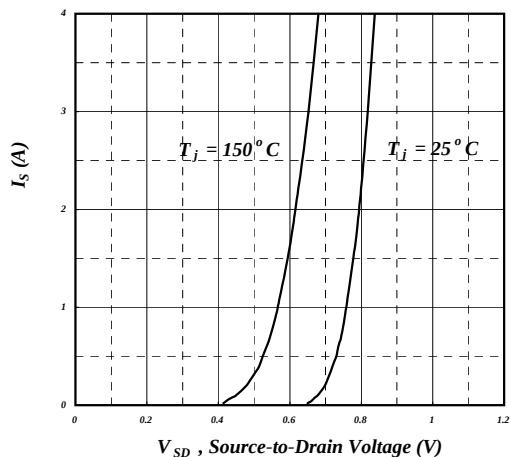


Fig 5. Forward Characteristic of
Reverse Diode

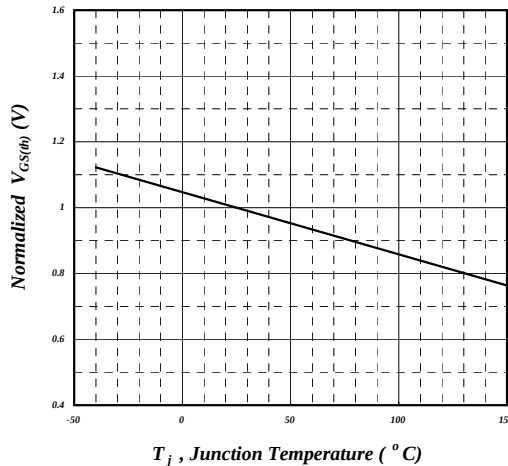
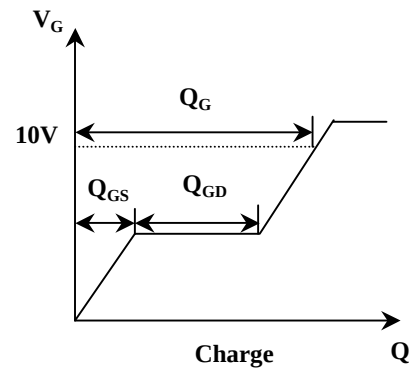
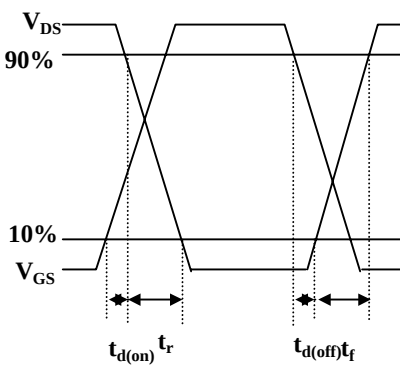
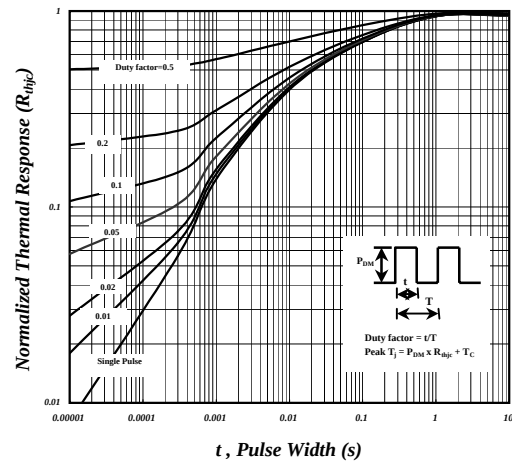
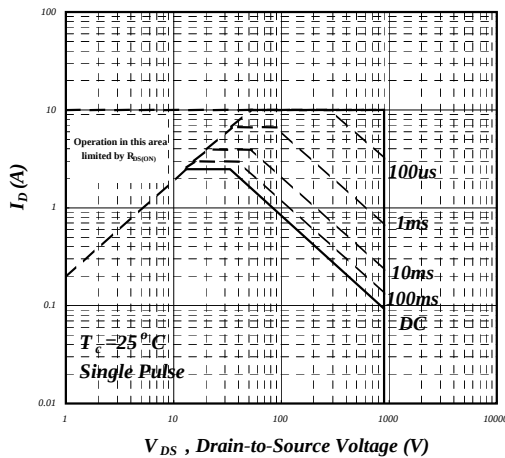
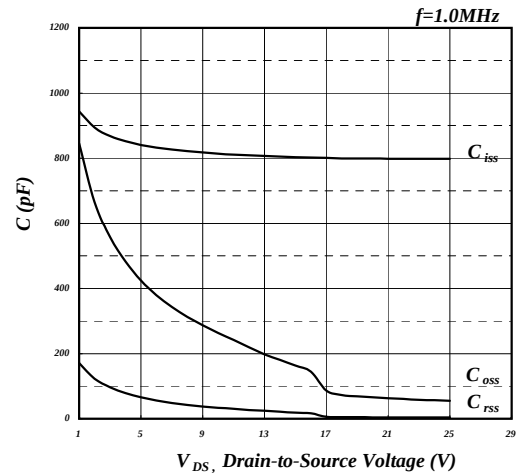
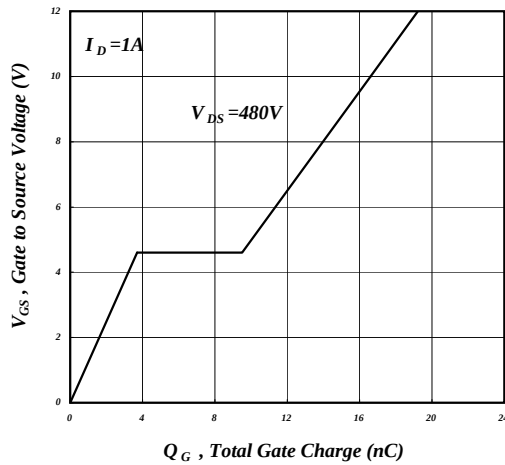


Fig 6. Gate Threshold Voltage vs.
Junction Temperature

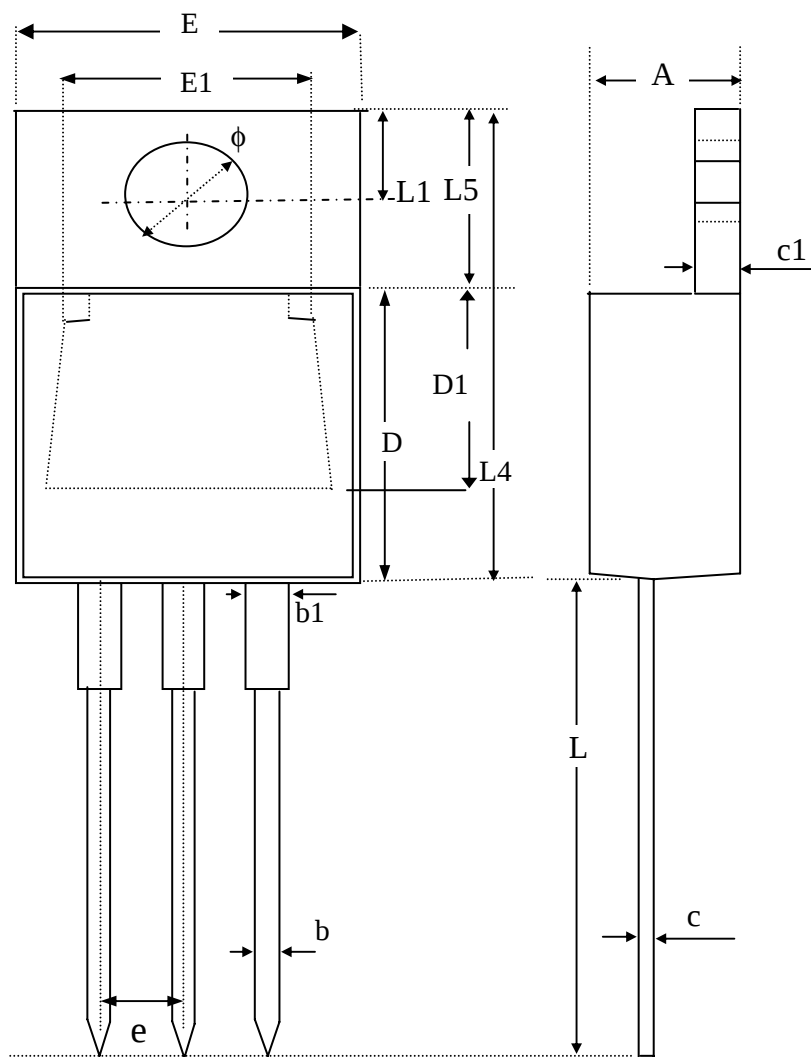


Typical Electrical Characteristics (cont.)





Package Dimensions: TO-220



SYMBOLS	Millimeters		
	MIN	NOM	MAX
A	4.40	4.60	4.80
b	0.76	0.88	1.00
D	8.60	8.80	9.00
c	0.36	0.43	0.50
E	9.80	10.10	10.40
L4	14.70	15.00	15.30
L5	6.20	6.40	6.60
D1	5.10 REF.		
c1	1.25	1.35	1.45
b1	1.17	1.32	1.47
L	13.25	13.75	14.25
e	2.54 REF.		
L1	2.60	2.75	2.89
φ	3.71	3.84	3.96
E1	7.4 REF.		

1. All dimensions are in millimeters.
2. Dimensions do not include mold protrusions.

Marking Information

